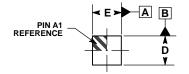
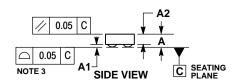


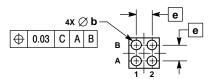
## 

SCALE 4:1



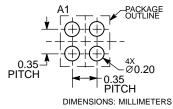






**BOTTOM VIEW** 

## RECOMMENDED SOLDERING FOOTPRINT\*



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DATE 25 JAN 2018

NOTES: 1. DIMENSIONING AND TOLERANCING PER

DIMENSIONING AND TOLERANGING FER ASME Y14.5M, 1994.
CONTROLLING DIMENSION: MILLIMETERS.
COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.



	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α			0.33	
A1	0.04	0.06	0.08	
A2	0.23 REF			
b	0.180	0.200	0.220	
D	0.610	0.640	0.670	
ш	0.610	0.640	0.670	
e	0.35 BSC			

GENERIC **MARKING DIAGRAM\*** 



= Specific Device Code Х Μ = Month

\*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

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WLCSP4, 0.64x0.64x0.33

CASE 567VS

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